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LX5208

18-LINE LOW CAPACITANCE, µPOWER SCSI TERMINATOR

PRODUCTION DATA SHEET

DESCRIPTION

The LX5208 is an eighteen-line active terminator for the SCSI parallel bus. This SCSI standard recommends active termination at both ends of the SCSI bus.

During disconnect mode, the LX5208 requires a meager 60µA of supply current while offering only 3.5pF of output capacitance. To enter this low-power mode, the disconnect pin can be left open (floating) or driven high, thereby disconnecting the terminating resistors and placing the internal low dropout regulator into low-power mode. In disconnect mode, each termination line presents a high impedance to the SCSI bus with the overall effect being to preserve high signal integrity and yield subsequent reliable, error free communications.

During normal operation, the LX5208 consumes only 800µA of current, which is the lowest enabled supply current of any terminator available on the market today. Linfinity's proprietary BiCMOS low dropout regulator architecture enables this unique and very efficient operating characteristic.

The LX5208 also offers a precisely trimmed channel output current specified to a 5% tolerance. The maximum value of the output current is trimmed as closely as possible to the SCSI standard maximum specification to give the highest possible noise margin for fast SCSI operation. And the LX5208 sinks up to 200mA of current making it compatible with today's fast active negation drivers.

The LX5208 is a superior, pin-for-pin replacement for a variety of industry products such as the UC5601, UC5602, UC5608, and UC5609.

KEY FEATURES

- 3.5pF OUTPUT CAPACITANCE DURING DISCONNECT

- 60µA SUPPLY CURRENT IN DISCONNECT MODE

- 800µA SUPPLY CURRENT DURING NORMAL OPERATION

- 200mA SINK CURRENT FOR ACTIVE NEGATION

- LOGIC COMMAND DISCONNECTS ALL TERMINATION LINES

- CURRENT LIMIT AND THERMAL PROTECTION

- COMPATIBLE WITH SCSI 1, 2 AND 3 STANDARDS

- CONSULT FACTORY FOR APPLICATION TEST REPORT: **5208TR**

PRODUCT HIGHLIGHT

RECEIVING WAVEFORM - 10MHZ

DRIVING WAVEFORM - 10MHZ

Receiver / Driver / 1 Meter, AWG 28 / LX5208 / LX5268 / LX5208 / LX5268
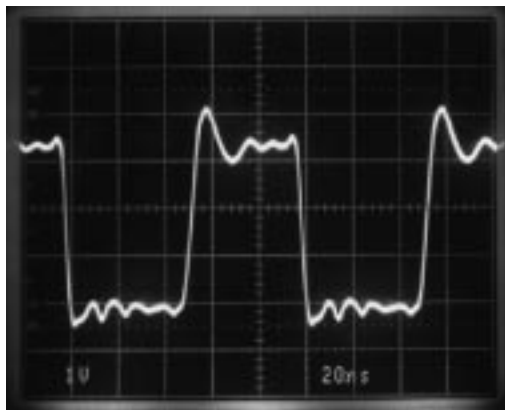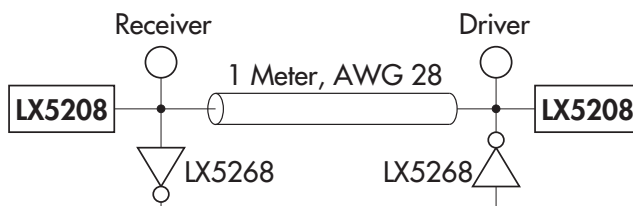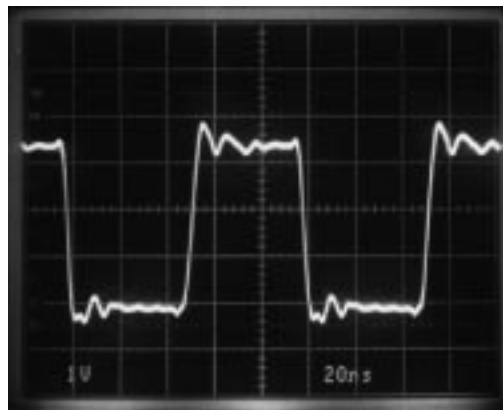
─── NOTE: ───
For An In-Depth Discussion On Applying SCSI, Request Linfinity Application Note: "Understanding The Single-Ended SCSI Bus"

PACKAGE ORDER INFO

T$_A$ (°C)	DWP Plastic SOWB 28-pin, Power
0 to 70	LX5208CDWP

Note: All surface-mount packages are available in Tape & Reel. Append the letter "T" to part number. (i.e. LX5208CDWPT)

FOR FURTHER INFORMATION CALL (714) 898-8121

ABSOLUTE MAXIMUM RATINGS   (Note 1)

TermPwr Voltage .... +7V
Signal Line Voltage .... 0V to +7V
Regulator Output Current 1.2A
Operating Junction Temperature
    Plastic (DWP Package).. 150°C
Storage Temperature Range .... -65°C to 150°C
Lead Temperature (Soldering, 10 seconds) .... 300°C

Note 1.   Exceeding these ratings could cause damage to the device. All voltages are with respect
to Ground. Currents are positive into, negative out of the specified terminal.

THERMAL DATA

DWP PACKAGE:

THERMAL RESISTANCE-JUNCTION TO LEADS, θ_{JL}	18°C/W
THERMAL RESISTANCE-JUNCTION TO AMBIENT, θ_{JA}	40°C/W

Junction Temperature Calculation: $T_J = T_A + (P_D \times \theta_{JA})$.
The θ_{JA} numbers are guidelines for the thermal performance of the device/pc-board system.
All of the above assume no ambient airflow.

PACKAGE PIN OUTS

DISCONNECT	1	28	GND
T1	2	27	T18
T2	3	26	T17
T3	4	25	T16
T4	5	24	T15
T5	6	23	T14
HEAT SINK	7	22	HEAT SINK
HEAT SINK	8	21	HEAT SINK
HEAT SINK	9	20	HEAT SINK
T6	10	19	T13
T7	11	18	T12
T8	12	17	T11
T9	13	16	T10
V_{TERM}	14	15	REG OUT

DWP PACKAGE
(Top View)

POWER UP / POWER DOWN FUNCTION TABLE

Disconnect	Outputs	Quiescent Current
L	Enabled	800µA
H	HI Z	60µA
Open	HI Z	60µA

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RECOMMENDED OPERATING CONDITIONS (Note 2)

| Parameter	Symbol	Recommended Operating Conditions			Units
		Min.	Typ.	Max.	
TermPwr Voltage	V_{TERM}	4		5.25	V
Signal Line Voltage		0		5	V
Disconnect Input Voltage		0		V_{TERM}	V
Output Capacitance on REGOUT		4.7			µF
Operating Virtual Junction Temperature Range					
LX5208C		0		70	°C

Note 2. Range over which the device is functional.

ELECTRICAL CHARACTERISTICS

(Unless otherwise specified, these specifications apply over the operating ambient temperature range of 0°C ≤ T_A ≤ 70°C. TermPwr = 4.75V, Disconnect = 0V. Low duty cycle pulse testing techniques are used which maintains junction and case temperatures equal to the ambient temperature.)

Parameter	Symbol	Test Conditions	LX5208			Units
			Min.	Typ.	Max.	
Supply Current Section						
TermPwr Supply Current		All term lines = Open		0.8	1.5	mA
		All term lines = 0.5V		390	430	mA
Power Down Mode		Disconnect = Open		60	100	µA
Output Section (Terminator Lines)						
Terminator Impedance		I_{TERM} = -5mA to -15mA	100	110	120	Ω
Terminator Output High Voltage			2.7	2.9		V
Max. Output Current		V_{OUT} = 0.5V, T_A = 25°C	-20.3	-21.8	-23	mA
		V_{OUT} = 0.5V, 0°C ≤ T_A ≤ 70°C	-19.0	-21.8	-23	mA
		V_{OUT} = 0.5V, V_{TERM} = 4V, T_A = 25°C	-19.5	-21.8	-23	mA
		V_{OUT} = 0.5V, V_{TERM} = 4V, 0°C ≤ T_A ≤ 70°C	-18.0	-21.8	-23	mA
Output Leakage		Disconnect = Open, V_{TERM} = 0V to 5.25V		10	400	nA
Output Capacitance		Disconnect = Open		3.5		pF
Sink Current		V_{OUT} = 4V	58	70		mA
Regulator Section						
Regulator Output Voltage				3.6		V
Line Regulation		V_{TERM} = 4V to 6V		10	20	mV
Load Regulation		I_{REG} = 0 to -100mA		20	50	mV
Drop Out Voltage		I_{REG} = -100mA		0.45	1.0	V
Short Circuit Current		V_{REG} = 0V		-700	-1000	mA
Thermal Shutdown				150		°C
Disconnect Section						
Disconnect Threshold			0.8		2.0	V
Input Current		Disconnect = 0V			40	µA

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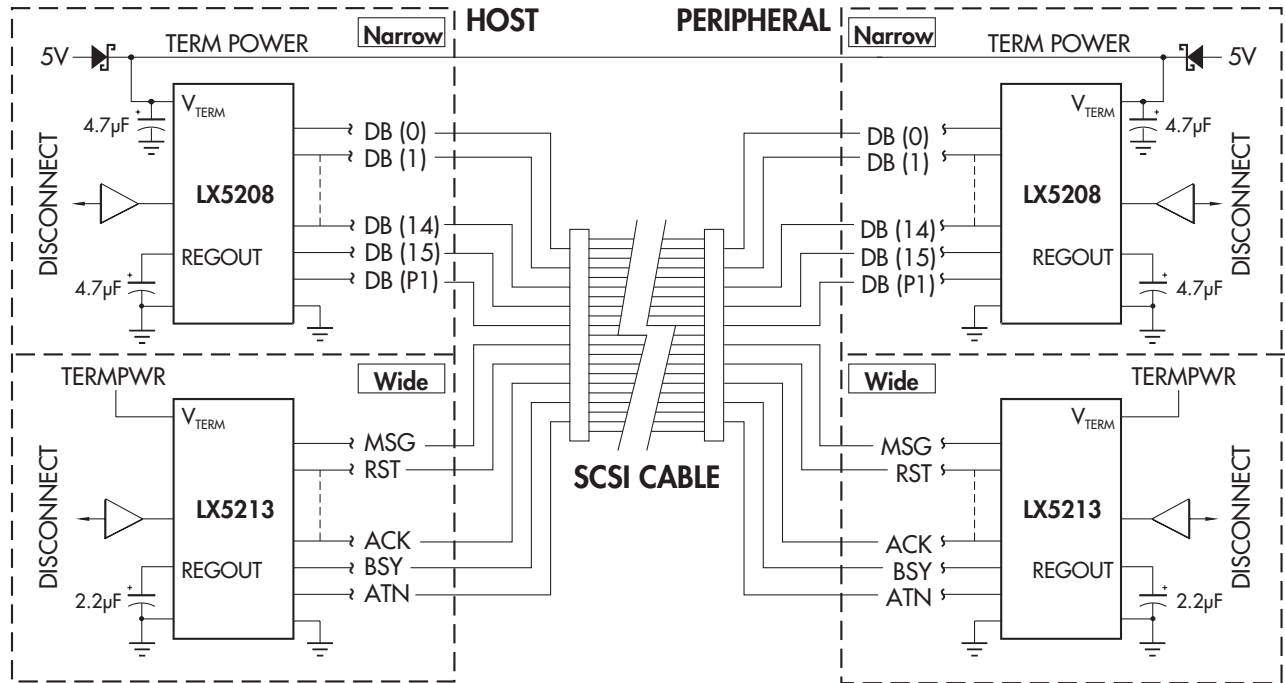
BLOCK DIAGRAM

FIGURE 1 — LX5208 BLOCK DIAGRAM
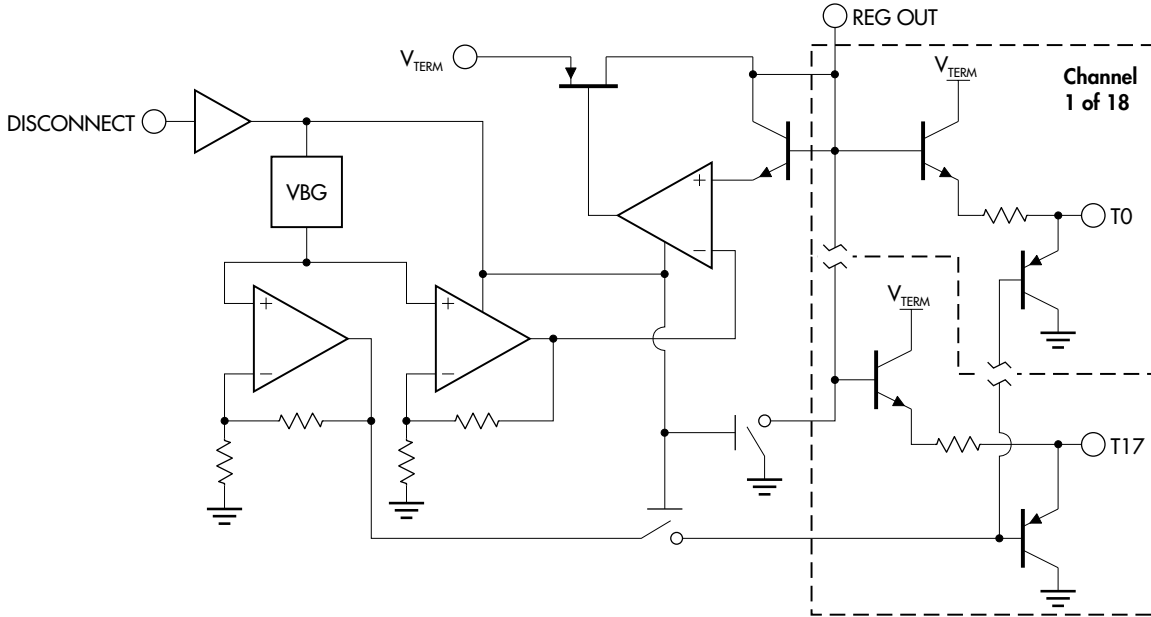
APPLICATION SCHEMATIC

FIGURE 2 — 8/16-BIT SCSI SYSTEM APPLICATION

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